

6367254 MOTOROLA SC (XSTRS/R F)

96D 81964 D

T-31-15

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	15	V <sub>dc</sub>
Collector-Base Voltage	V <sub>CBO</sub>	25	V <sub>dc</sub>

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board,* T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225	mW
Thermal Resistance Junction to Ambient	R <sub>θJA</sub>	556	°C/mW
Total Device Dissipation Alumina Substrate,** T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300	mW
Thermal Resistance Junction to Ambient	R <sub>θJA</sub>	417	°C/mW
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	150	°C

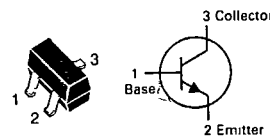
\*FR-5 = 1.0 x 0.75 x 0.62 in.  
\*\*Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

**DEVICE MARKING**

BFS17 = E1
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**BFS17**

CASE 318-02/03, STYLE 6  
SOT-23 (TO-236AA/AB)



**RF TRANSISTOR**  
NPN SILICON



**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted.)**

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Breakdown Voltage (I <sub>C</sub> = 10 mA)	V <sub>(BR)CEO</sub>	15	—	V <sub>dc</sub>
Collector-Base Breakdown Voltage (I <sub>C</sub> = 100 μA)	V <sub>(BR)CBO</sub>	25	—	V <sub>dc</sub>
Collector Cutoff Current (V <sub>CE</sub> = 10 V)	I <sub>CEO</sub>	—	25	nA
Collector Cutoff Current (V <sub>CB</sub> = 10 V)	I <sub>CBO</sub>	—	25	nA
Emitter Cutoff Current (V <sub>EB</sub> = 4.0 V)	I <sub>EBO</sub>	—	100	μA
<b>ON CHARACTERISTICS</b>				
DC Current Gain (I <sub>C</sub> = 2.0 mA, V <sub>CE</sub> = 1.0 V) (I <sub>C</sub> = 25 mA, V <sub>CE</sub> = 1.0 V)	h <sub>FE</sub>	20 20	150 —	—
Collector-Emitter Saturation Voltage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1.0 mA)	V <sub>CE(sat)</sub>	—	0.4	V
Base-Emitter Saturation Voltage (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1.0 mA)	V <sub>BE(sat)</sub>	—	1.0	V
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Current-Gain — Bandwidth Product (I <sub>C</sub> = 2.0 mA, V <sub>CE</sub> = 5.0 V, f = 500 MHz) (I <sub>C</sub> = 25 mA, V <sub>CE</sub> = 5.0 V, f = 500 MHz)	f <sub>T</sub>	1.0 1.3*	— —	GHz
Output Capacitance (V <sub>CB</sub> = 10 V, f = 1.0 MHz)	CCB	—	1.0*	pF
Noise Figure (I <sub>C</sub> = 2.0 mA, V <sub>CE</sub> = 5.0 V, R <sub>S</sub> = 50 Ω, f = 30 MHz)	NF	—	5.0*	dB

\*Typ